SM16704PB

Feature

- Built-in power clamp, support input power-supply voltage
 5~24V
- OUTR/ G/ B constant current value defaults to 17mA
- ◆ OUTR/ G/ B power-on state: off
- OUTR/ G/ B port withstand voltage 26V
- ◆ OUTR/ G/ B output grayscale: 256 level
- Display data synchronization refresh in the same frame
- ◆ Single-line return-to-zero code SID data protocol
- Data serial cascade transmission, strong anti-interference ability
- Signal transfer rate: 800kbps
- Package: SOP8

Application

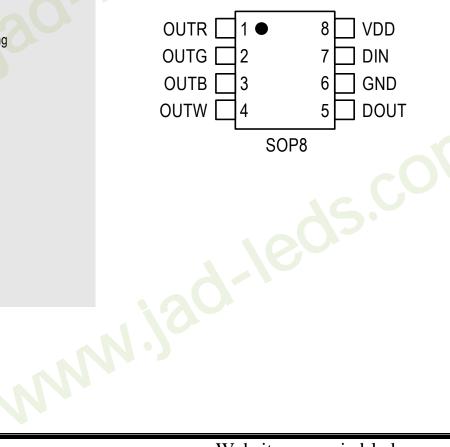
- ◆ Indoor LED decorative lighting
- Architecture exterior/circumstance lighting
- Point source, perforation
- Soft light strip, line light

Description

The SM16704PB is a single-line transmission 4-channel output LED driver, which adopts single-line return-to-zero code SID data protocol.

The SM16704PB default output current of the OUT R/G/B/W port is 17mA. The peripheral components of the chip are few, simple and reliable.

Pin Diagram



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Internal Function Diagram

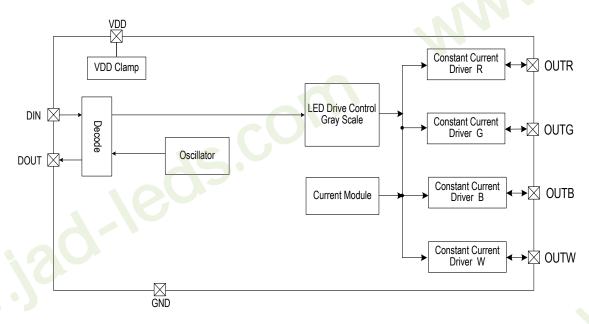


Fig. SM16704PB internal function diagram

Pin Definition

Pin No.	Pin Name	Description			
1	OUTR	Constant current drive port			
2	OUTG	Constant current drive port			
3	OUTB	Constant current drive port			
4	OUTW	Constant current drive port			
5	DOUT	Cascaded signal output			
6	GND	Ground			
7	DIN	Signal input port			
8	VDD	Power port			

Order Information

Typo	Type Package		Packing			
туре	гаскаде	Tube	Таре	Reel Size		
SM16704PB	SOP8	100000 pcs/box	4000 pcs/tape	13 inches		
	N	WN .				

Absolute Maximum Parameter (Note 1)

Unless otherwise stated, TA=25°C.

Symbol	Description	Range	Unit
V_{DD}	IC power voltage	-0.4~+5.5	V
Vı	Logic input voltage	-0.4~VDD+0.4	V
BV _{OUT}	R/G/B withstand voltage	30	V
Іоит	R/G/B Output current	18	mA
RθJA	PN junction to ambient thermal resistance (Note 2)	130	°C/W
P _D	Power consumption (Note 3)	0.5	W
TJ	Operating junction temperature range	-40~150	°C
Тѕтс	Storage temperature range	-55~150	°C
V _{ESD}	HBM ESD	2	KV

Note 1: The maximum output power is limited to chip junction temperature, the maximum limit means that the chip can be damaged beyond the scope of the work. The maximum limit value is the work in the limit parameter range, the device function is normal, but it is not completely guaranteed to meet the individual performance indexes.

Note 2: R0JA measures the flow of water according to the JEDEC JESD51 thermal measurement standard on the single-layer thermal conductivity test board under T_A=25°C.

Note 3: The maximum power consumption is decreased when temperature rising, this depends on T_{JMAX} , $R\theta JA$ and T_A Maximum allowable power consumption is $P_D = (T_{JMAX} - T_A)/R\theta JA$ or the lower value of the value given in the limit range.

Electrical Operating Parameter (Note 4, 5)

Unless otherwise stated, V_{DD} = 5.0V, T_A=25°C.

Symbol	Description	Condition	Min.	Тур.	Max.	Unit
VDD Internal clamp voltage		External power VCC=12V, current limiting resistor RD =1KΩ between VCC and VDD	4.8	5.2	5.5	V
	Power voltage	VCC≤5V	3.0	-	5.0	V
IDD	Quiescent current	VDD = 4. 5V,IOUT "OFF"	-	1.2	-	mA
VIH		DIN input high level		-	-	٧
VIL	Input signal threshold voltage	DIN input low level	-	-	0.3×VDD	V
ЮН	DOUT output current	DOUT output is high, serially connect 10Ω resistor to GND		-40		mA
IOL	DOUT sink current	DOUT output is low, shorted to VDD		40	-	mA
VDS_S	OUT R/G/B/W constant current knee point voltage	IOUT = 17mA		0.8	-	V
%VS.VDS		IOUT = 17mA, VDS =1.0~3.0V	-	0.5	-	%
%VS.VDD	OUT R/G/B/W output current variation	IOUT =17mA,VDD = 4.5~5.5V	-	0.5	-	%
%VS.TA		IOUT = 17mA, TA= -40~+85℃	-	5.0	-	%
lleak	OUT R/G/B/W leakage current	VDS =26V,IOUT "OFF"	-	-	1	uA

Note 4: The electrical operating parameters define the DC parameters of the device within the working range and under test conditions that ensure a specific performance indicator. The specification does not guarantee the accuracy of the parameters that are not given the upper and lower limit values, but the typical values reflect the performance of the device.

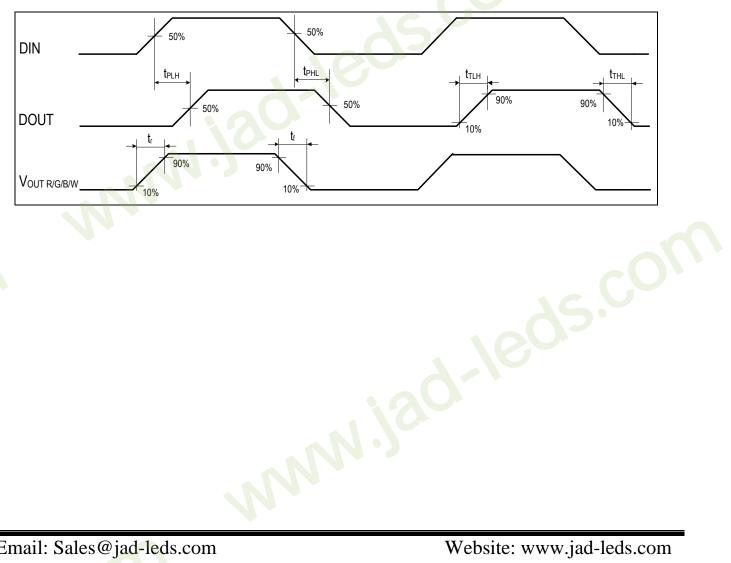
Note 5: The minimum and maximum parameter range of the datasheet is guaranteed by the test, and the typical value is guaranteed by design, test or statistical analysis.

Switching Characteristic

Unless otherwise stated, TA=25°C.

Symbol	Description	Measurement Condition	Min.	Тур.	Max.	Unit
f _{PWM}	OUT R/G/B output PWM frequency	I _{OUT} =17mA, OUT port serially connects 200Ω resistor to VDD	-	1.2	1	KHz
tрLн	Signal transmission delay	DOUT port load capacitance to ground is 30pF, DIN to DOUT signal	-	85	ı	ns
tphL	(Note 6)	transmission delay	-	70	-	ns
tтьн	DOUT	DOUT II I I I I I I I I I I I I I I I I I		18	-	ns
tтнL	Conversion time (Note 7)	DOUT port load capacitance to ground is 30pF	-	20	-	ns
tr	OUT R/G/B	I _{OUT R/G/B/W} =17mA, OUT R/G/B port serially connects 200Ω resistor to		55	-	ns
tf	Conversion time (Note 8)	VDD, load capacitance to ground is 15pF	-	75	-	ns

Note 6, note 7 and note 8: as shown below



Data Communication Protocol (Note 9, 10)

1. Code Description

The protocol of the SM16704PB adopts single polarity RZ code, LOW level must be contained in each code element. Each code element in the protocol initiates with HIGH level, and the width of the HIGH level time determines 0 code or 1 code.

Input code type:

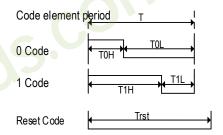


Fig. SM16704PB RZ code data communication protocol diagram

		1 Code ←	T1H T1I	→		
		Reset Code 🕌	Trst			
		Fig. SM16704PB RZ code data	communication p	orotocol diagram		
	Symbol	Parameter	Min.	Тур.	Max.	Unit
" VIA	T	Code element period	1200	-	1	ns
	ТОН	0, HIGH level	200	300	400	ns
	TOL	0, LOW level	800	900	-	ns
	T1H	1, HIGH level	800	900	1000	ns
	T1L	1, LOW level	200	300	-	ns
	Trst	Reset, LOW level	200		-	us

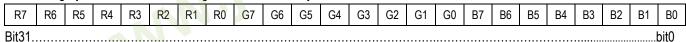
Note 9: when writing the program, the minimum code period is 1.2us;

Note 10: The high level time of 0 and 1 code should be in accordance with the specified scope of the above table, and the low level time of 0 yards and 1 yard is less than 20us;

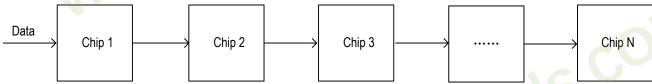
2 Protocol Data Format:

Trst+ First chip 32bits data +Second chip 32bits data +.....+ The N chip 32bits data +Trst

32bits gray scale data structure: High levels first, sent by the order of RGB



System Topological Graph:



Input Data Stream of every chip (3 chips as an example):



Constant Current characteristics

After reaching the constant current knee point, the SM16704PB output current is not affected by the OUT port voltage VDS.



Typical Application

Typical application circuit diagram of SM16704PB RGB scheme

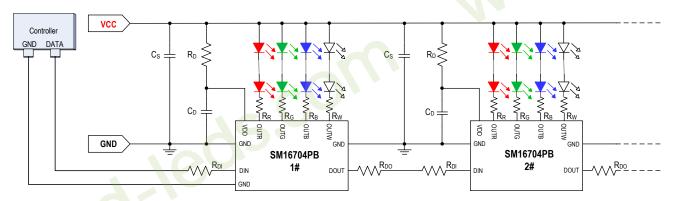


Fig. SM16704PB typical application diagram

SM16704PB typical application circuit parameters include external input voltage VCC, system power supply filter capacitor C_S, chip current limiting resistor R_D, VDD voltage regulator capacitor C_D and OUTR/G/B LED voltage divider resistor R_R, R_G, R_B, DAI signal input port cascades resistor R_{DI} and DAO signal output port cascades resistor R_{DO}.

(1) VCC is the external input voltage, and R_D is the current limiting resistor, which is used to limit the operating current of the internal voltage regulator module when the chip voltage regulator function is turned on. Chip operating voltage, $VDD = VCC - I_{DD} \times R_D$, where I_{DD} is the chip quiescent current, R_D resistance must ensure VDD >3V. The larger the R_D resistance is, the lower the system power consumption is, but the system anti-interference ability is weak; the smaller the R_D resistance is, the larger the system power consumption is, the higher the operating temperature is. The design needs to properly select the resistor R_D according to the system application environment. The design reference values of different input power supply voltages VCC and current limiting resistor R_D are as follows:

VCC(V)	5	6	9	12	15	18	24
$R_D(\Omega)$	33	100	470	1K	1.5K	2K	3K

- (2) C_S is the capacitance of the system power to ground, used to reduce power fluctuations, can choose 0.1uF~10uF capacitor according to the actual load of the system, when the load is large, it is recommended to choose electrolytic capacitor;
- (3) The C_D is a chip filter capacitor, which is used to stabilize the VDD voltage of the chip to ensure the normal operation of the chip. The C_D is recommended to be a 100nF capacitor;
- (4) R_D is a DAI signal input port protection resistor to prevent damage to the signal port caused by hot plugging, reverse polarity of the power supply and reverse connection of the signal line.
- (5) R_{DO} is a DAO signal output port protection resistor to prevent damage to the signal port caused by hot plugging, reverse polarity of the power supply and reverse connection of the signal line.
- (6) R_R , R_G , and R_B are voltage divider resistors of the OUTR/G/B port, which are used to reduce the OUTR/G/B port voltage and reduce the power consumption of the chip. The calculation formula is

$$R_R/R_G/R_B/R_W$$
 (Ω) = $\frac{VCC - V_{DS} - N \times V_{LED}}{I_{OUT}}$

Where VCC is the external input voltage, VLED is the voltage drop of the LED lamp, IOUT is the port output current, and VDS is the

OUTR/G/B port voltage. In practical applications, the value of V_{DS} should be higher than the constant current inflection point voltage, and the chip will generate less power loss. The actual application is subject to the standard. The reference value of the voltage drop V_{LED} of different colors is as follows: the red lamp voltage drop is about 2.0~2.2V, and the green, blue and white lamp voltage drop is about 3.0~3.2V. Please refer to the actual lamp bead specification.

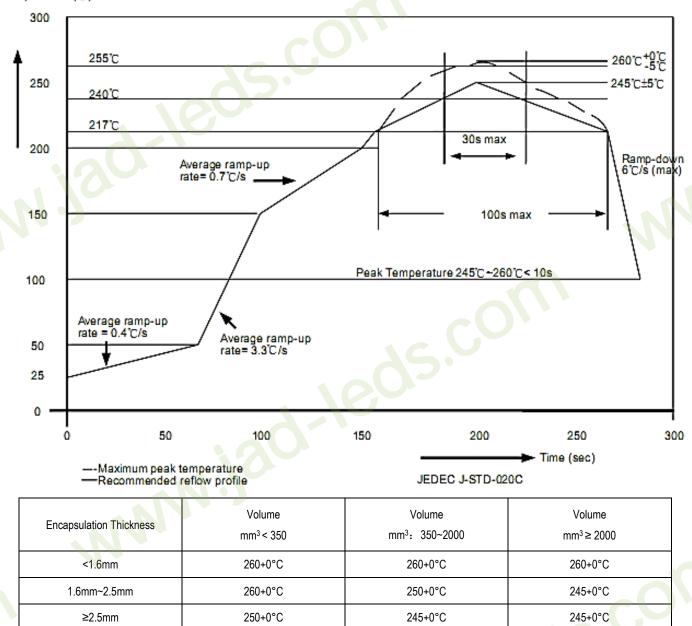
In a typical application, depending on the input voltage and the number of different beads, it is recommended that the values of the parameters be as follows:

VCC(V)	OUT port serial connection	$R_D(\Omega)$	C _D (nF)	$R_{DI}(\Omega)$	R _{DO} (Ω)	R _R (Ω)	R _G (Ω)	$R_B(\Omega)$	Rw(Ω)	
5	1	33	100	-	-	-	-	-	-	
12	3	1K	100	51	150	150	-	-	-	
24	6	3K	100	100	300	510	150	150	150	

Encapsulation Soldering Process

Semiconductors of Sunmoon follow the European RoHs standard, solder temperature in encapsulation soldering process follows J-STD-020 standard.

Temperature (°C)



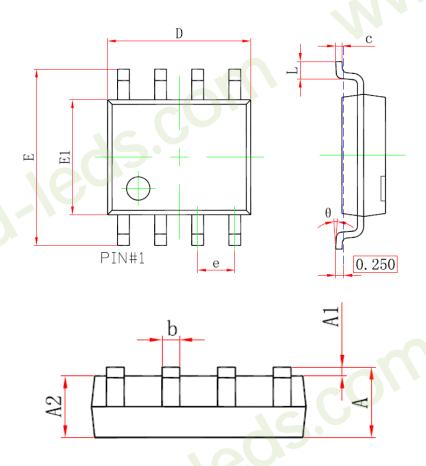
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WWW.

Package

SOP8



Symbol	Min(mm)	Max(mm)	
A	1.25	1.95	
A1	-	0.25	
A2	1.25	1.75	
b	0.25	0.7	
С	0.1	0.35	
D	4.6	5.3	
е	1.27(BSC)	
E	5.7	6.4	
E1	3.7	4.2	
L	0.2	1.5	
θ	0°	10°	

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